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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. : 10/667,825 Confirmation No.: 1009
Applicant(s) : Giuseppe Pedretti, et al.
Filed : September 22, 2003
TC/A.U. : 3729
Examiner : Thiem D. Phan
Title : Process for Manufacture of Printed Circuit Boards with Thick Copper Power Circuitry
Docket No. : 8245.060
Customer No. : 30589

Mail Box Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE

In response to the Office Action dated March 30, 2006, Applicants submit the following:

Listing of Claims begins on page **2** of this paper.

Remarks/Arguments begin on page **8** of this paper.